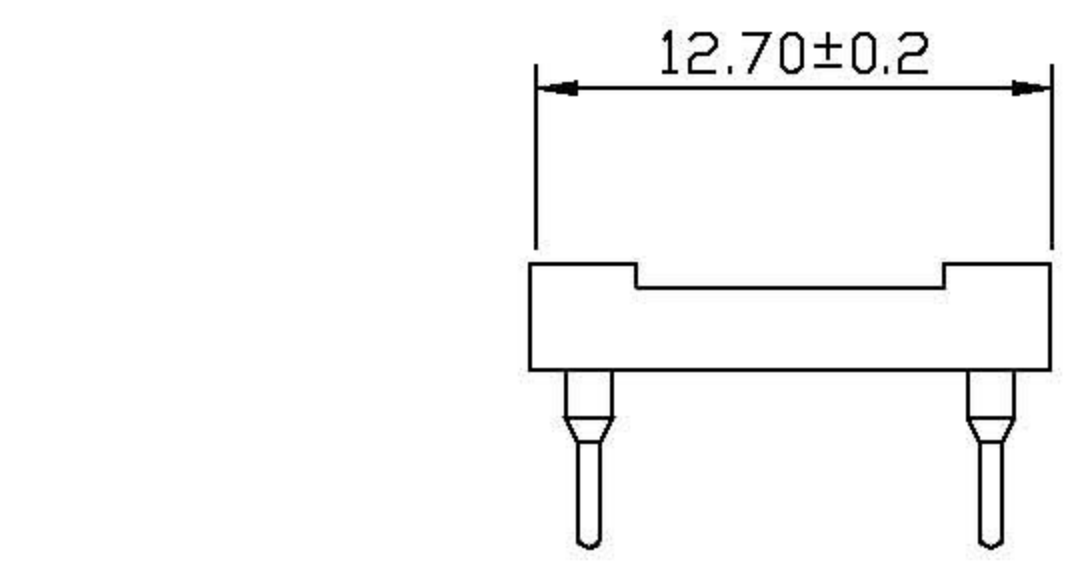

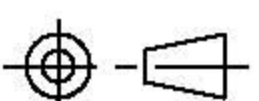


- MATERIAL & FINISH
- * CONTACT: BE CU
PLATING: 10 MICRO INCH GOLD
 - * SLEEVE: BRASS
PLATING: G=10 MICRO INCH GOLD
T=200 MICRO INCH TIN
 - * INSULATOR: GLASS FILLED POLYESTER, UL 94V-0
 - * INSERTION FORCE: AVERAGE 500 GR
 - * EXTRACTION TEST: AVERAGE 159 GR
 - * RESIST TO SOLDERING HEAT: MAX. 260°C, 5 SEC.
 - * CONTACT RESIST: < = 100M OHMS
 - * INSULATOR RESIST: > = 5000M OHMS
 - * DIELECTRIC WITHSTANDING: 600 VRMS
 - * TEMPERATURE: -55°C TO + 125°C



 易昕企業有限公司 LEAMAX ENTERPRISE CO., LED.					
PROJ		SCALE : F DO NOT SCALE DWG	MOLD NO	2121-XXEE	
APP			MODEL	FILE NO	REV.
CHK	CCJ	100.12.05	0.4"	22 Pin Machine Pin	X1
DGN	AMY	90.10.23	UNIT	SHT 1 OF 1	SIZE
DRW	SHIEH	90.10.23	MM		A4